

13 16 01

17

03/15/01
jc962 U.S. PRO

PATENT
LDC-MASK

31002 U.S. PRO
09/809606
10/31/01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

The Commissioner of Patents and Trademarks
Washington, D.C. 20231

Transmittal Letter

Submitted herewith for filing is a patent application of Paul D. Hammesfahr et al for REDUCING POLYMERIZATION STRESS BY CONTROLLED SEGMENTAL CURING, including an unexecuted Declaration.

The fee due is calculated as follows:


The filing fee is calculated as follows:

Basic Filing Fee		\$ 710.00
Total Claims	25 - 20 = 5 x 18 =	\$ 90.00
Independent Claims	13 - 3 = 10 x 80 =	\$ 800.00
Total filing fee		<u>\$1,600.00</u>

Please charge the fee due for filing in the amount of \$1,600.00 to Deposit Account 04-0750.

Please charge any additional fee due and credit any overpayment to Deposit Account No. 04-0780.

Respectfully submitted,


Douglas J. Bura
Patent Attorney Reg. No. 33749

March 14, 2001
Address of signer:

DENTSPLY INTERNATIONAL INC.
500 West College Avenue
York, PA 17403-0872
(717) 840-4466

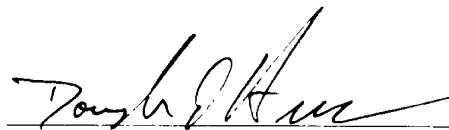
PATENT
F-MAIL

CERTIFICATE OF MAILING

By "EXPRESS MAIL"- Label No. EF177136029US

Date of Mailing by EXPRESS MAIL March 15, 2001

The patent application for LDC-MASK mailed by EXPRESS MAIL on
March 15, 2001.

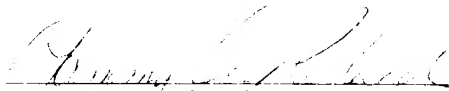


Douglas J. Hura

DENTSPLY INTERNATIONAL INC.
570 West College Avenue
York, Pennsylvania 17405

Physically delivered to the United States Post Office, York,
Pennsylvania by: Tammy A. Roland

I hereby certify that this paper or fee is being deposited with
the United States postal Service "EXPRESS MAIL First Office To
Addressee" service, under 37 CFR 1.10, on the date indicated above
and is addressed to Assistant Commissioner of Patents, Washington,
DC 20231.



Tammy A. Roland

Title: Patent Secretary

